

MOS FIELD EFFECT POWER TRANSISTOR
2SJ302, 302-Z

SWITCHING
 P-CHANNEL POWER MOS FET
 INDUSTRIAL USE

DESCRIPTION

The 2SJ302 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

- Low On-state Resistance
 $R_{DS(on)} \leq 0.1 \Omega$ ($V_{GS} = -10 V, I_D = -8 A$)
 $R_{DS(on)} \leq 0.24 \Omega$ ($V_{GS} = -4 V, I_D = -6 A$)
- Low C_{iss} $C_{iss} = 1\ 200\ pF$ TYP.
- Built-in G-S Gate Protection Diode

QUALITY GRADE

Standard

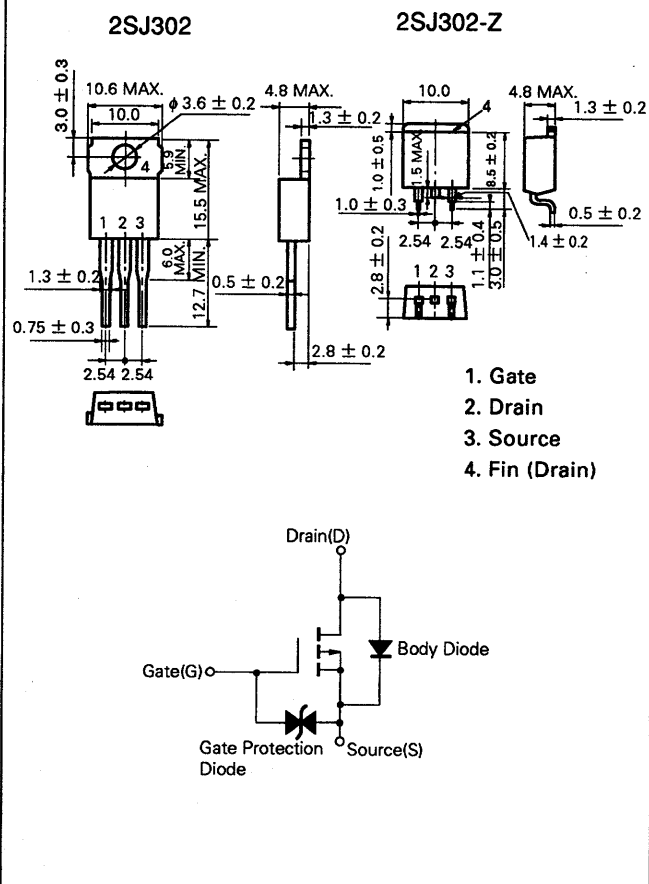
Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS ($T_a = 25\ ^\circ C$)

Drain to Source Voltage	V_{DSS}	-60	V
Gate to Source Voltage	V_{GSS}	-20, +10	V
Drain Current (DC)	$I_{D(DC)}$	∓ 16	A
Drain Current (pulse)	$I_{D(pulse)*}$	∓ 64	A
Total Power Dissipation ($T_c = 25\ ^\circ C$)	P_T	75	W
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature	T_{stg}	-55 to +150	$^\circ C$

* $PW \leq 10\ \mu s, Duty\ Cycle \leq 1\ %$

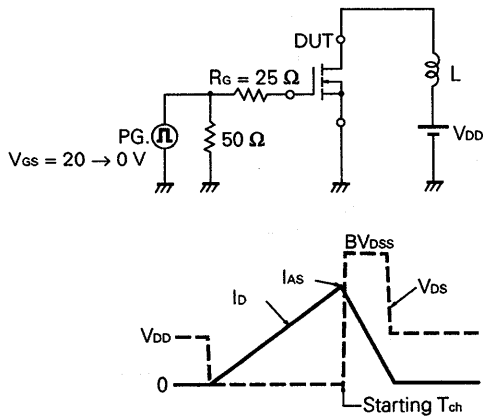
PACKAGE DIMENSIONS
 in millimeters



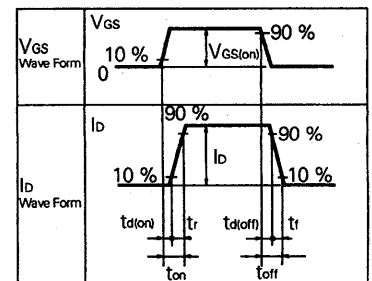
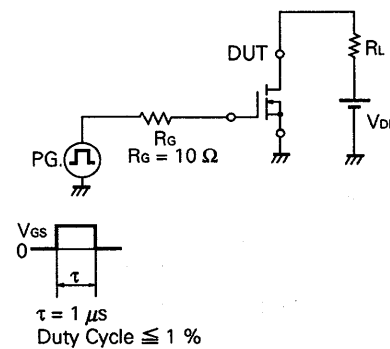
ELECTRICAL CHARACTERISTICS (T_a = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	R _{DS(on)}		75	100	mΩ	V _{GS} = -10 V, I _D = -8 A
Drain to Source On-state Resistance	R _{DS(on)}		130	240	mΩ	V _{GS} = -4.0 V, I _D = -6 A
Gate to Source Cutoff Voltage	V _{GS(off)}	-1.0		-2.0	V	V _{DS} = -10 V, I _D = -1 mA
Forward Transfer Admittance	Y _{fs}	5.0			S	V _{DS} = -10 V, I _D = -8 A
Drain Leakage Current	I _{DSS}			-10	μA	V _{DS} = -60 V, V _{GS} = 0
Gate to Source Leakage Current	I _{GSS}			±10	μA	V _{GS} = ±16 V, V _{DS} = 0
Input Capacitance	C _{iss}		1200		pF	V _{DS} = -10 V V _{GS} = 0 f = 1 MHz
Output Capacitance	C _{oss}		670		pF	
Reverse Transfer Capacitance	C _{rss}		290		pF	
Turn-On Delay Time	t _{d(on)}		30		ns	V _{GS(on)} = -10 V V _{DD} = -30 V I _D = -8 A, R _G = 10 Ω R _L = 3.75 Ω
Rise Time	t _r		170		ns	
Turn-Off Delay Time	t _{d(off)}		150		ns	
Fall Time	t _f		130		ns	
Total Gate Charge	Q _G		42		nC	V _{GS} = -10 V I _D = -16 A V _{DD} = -48 V
Gate to Source Charge	Q _{GS}		3		nC	
Gate to Drain Charge	Q _{GD}		17		nC	
Diode Forward Voltage	V _{SD}		1.0		V	I _F = -16 A, V _{GS} = 0
Reverse Recovery Time	t _{rr}		110		ns	I _F = -16 A, V _{GS} = 0
Reverse Recovery Charge	Q _{rr}		220		nC	di/dt = 50 A/μs

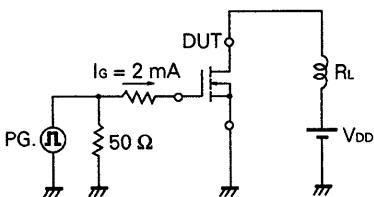
Test Circuit 1 : Avalanche Capability



Test Circuit 2 : Switching Time

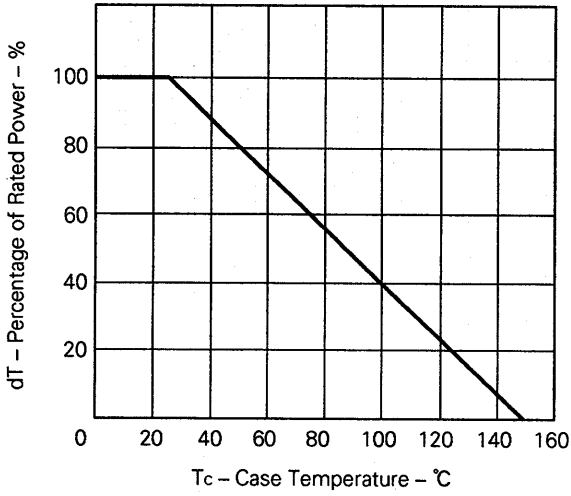


Test Circuit 3 : Gate Charge

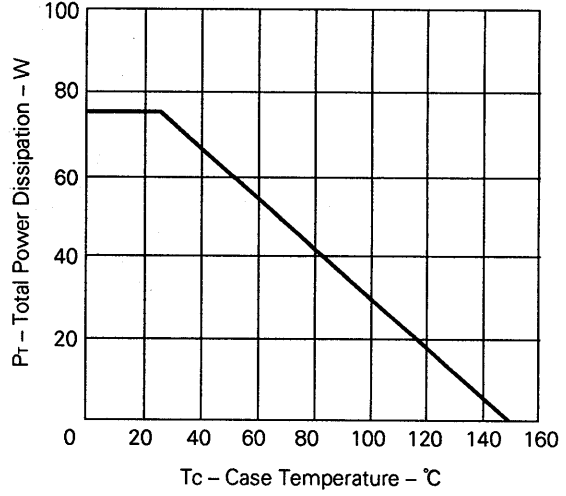


TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

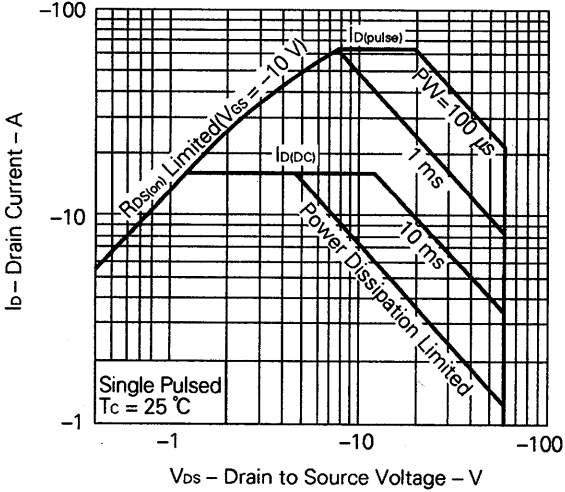
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



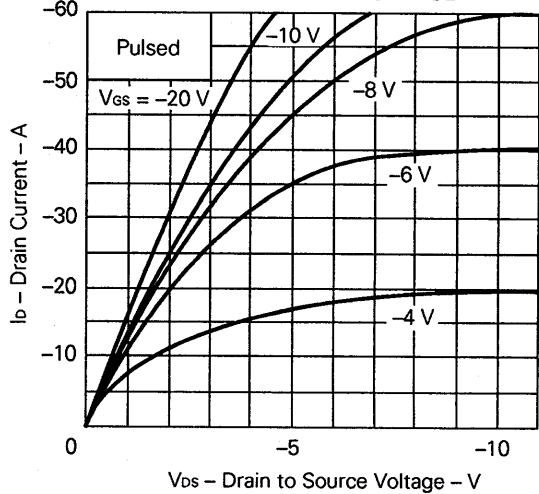
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



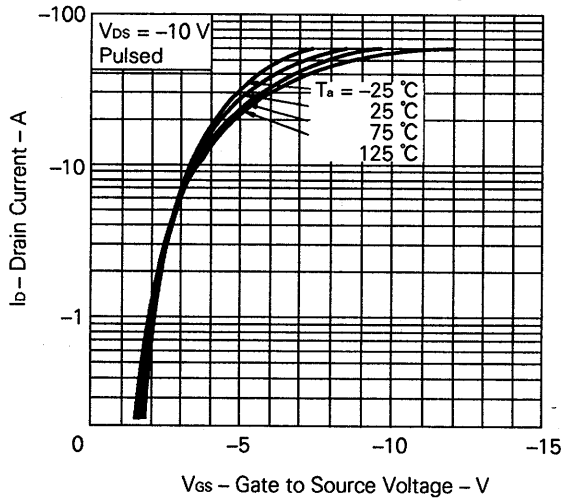
FORWARD BIAS SAFE OPERATING AREA



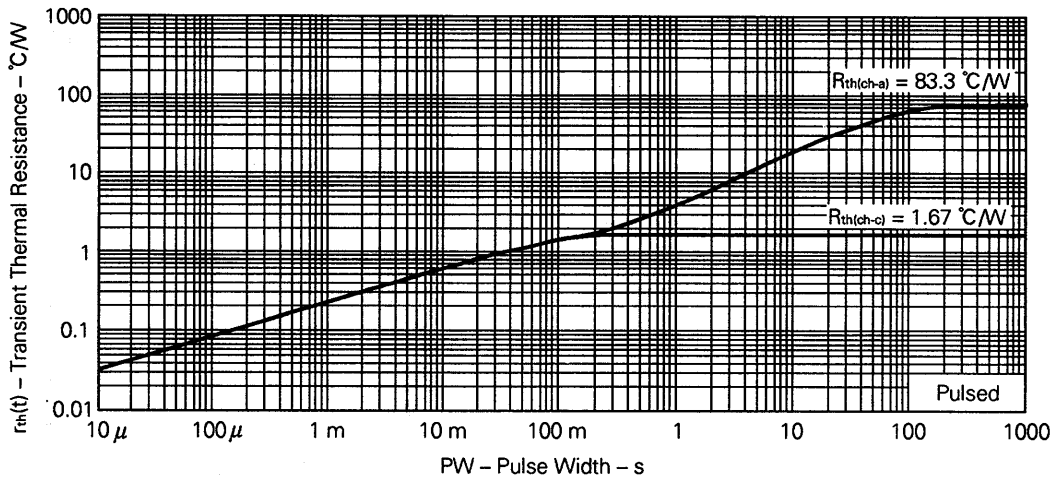
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



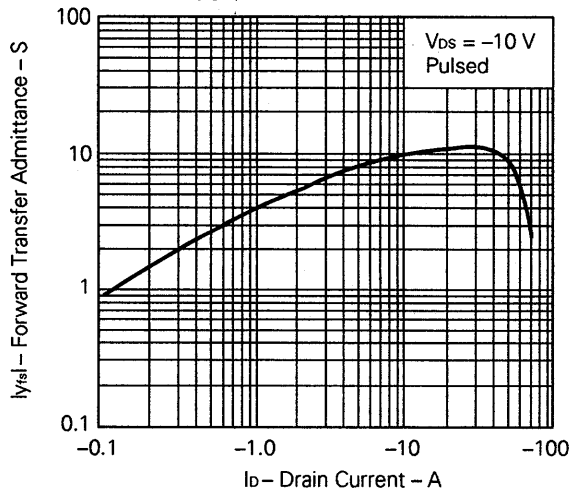
TRANSFER CHARACTERISTICS



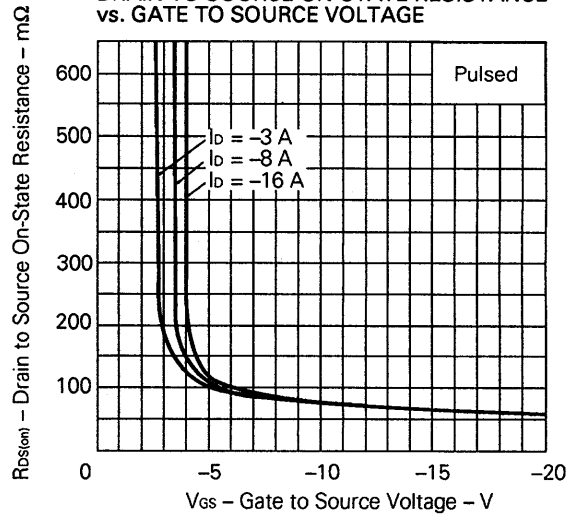
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



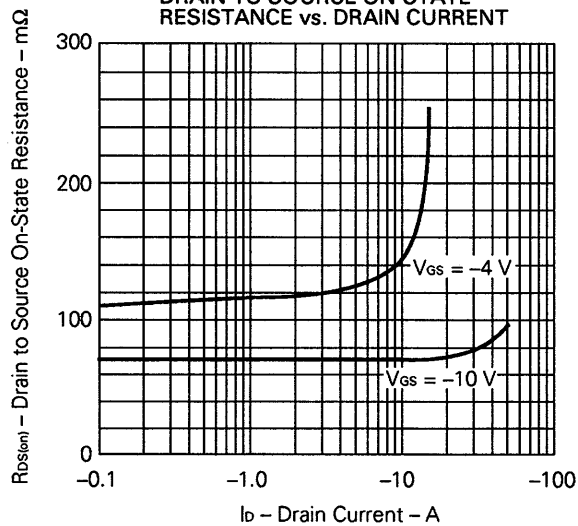
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



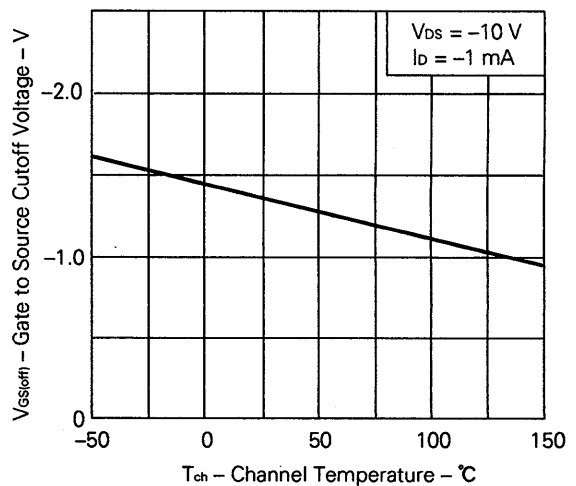
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

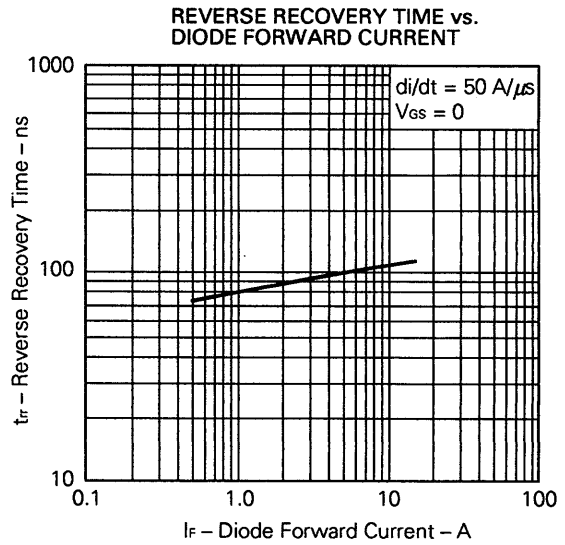
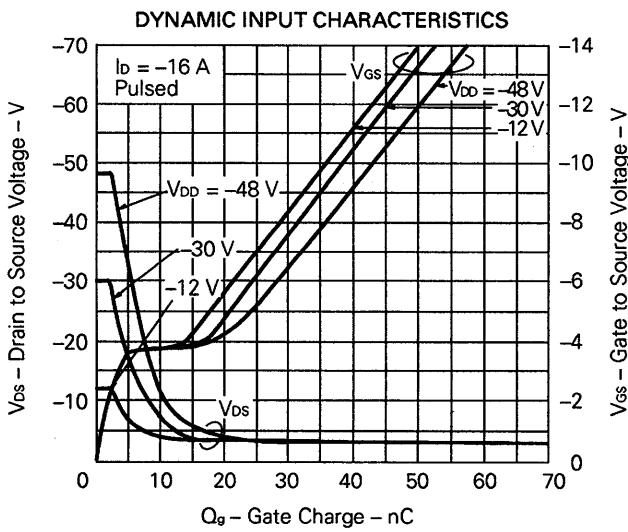
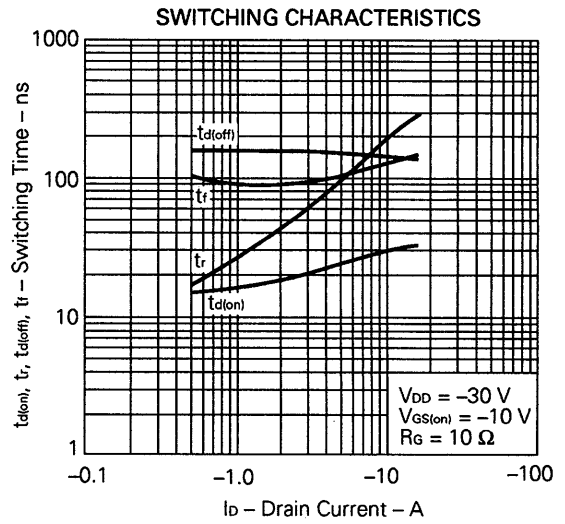
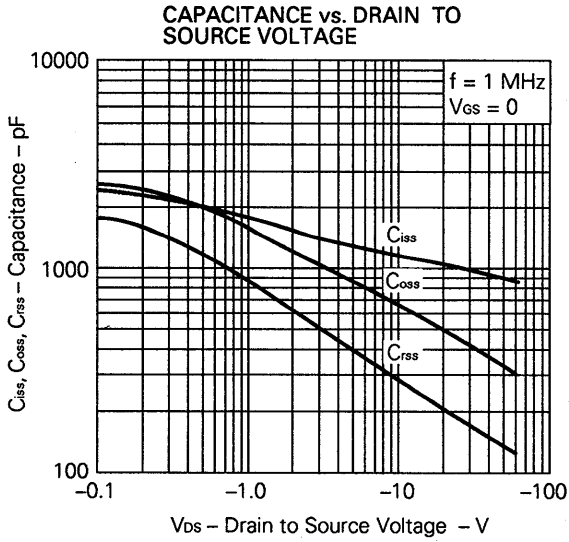
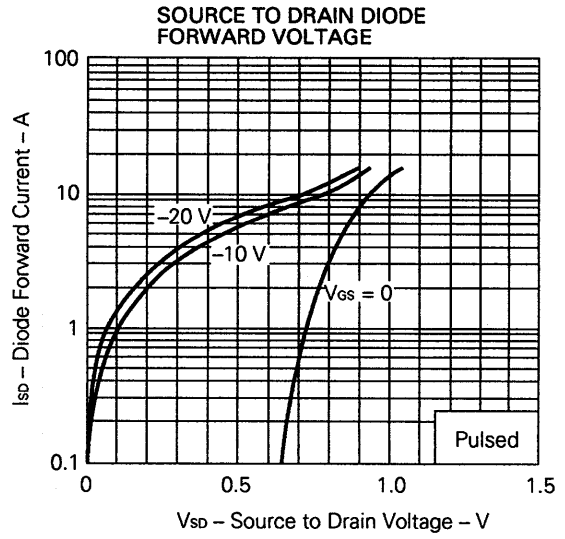
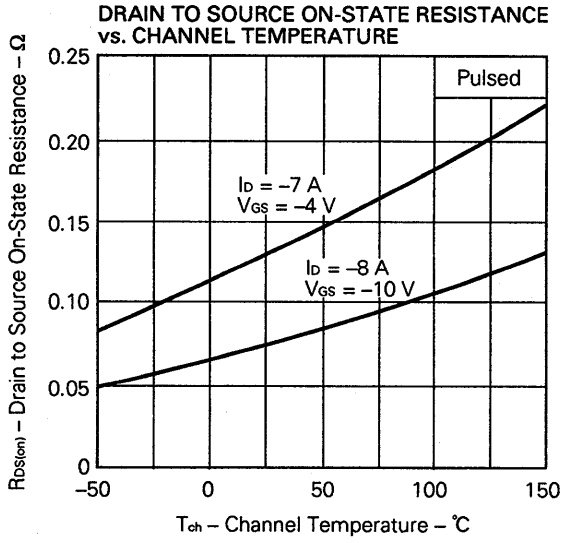


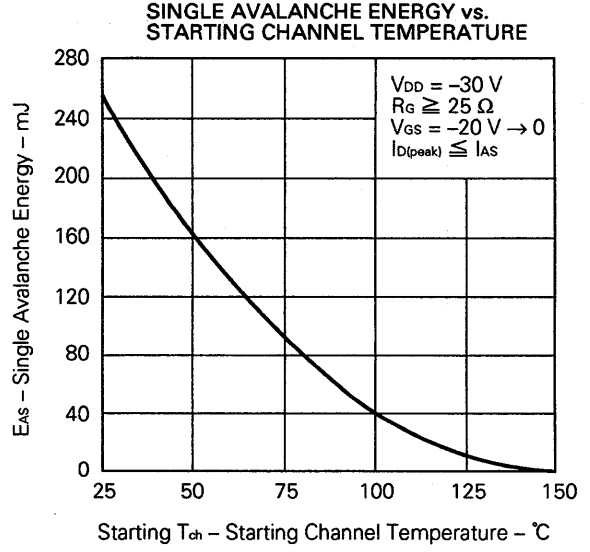
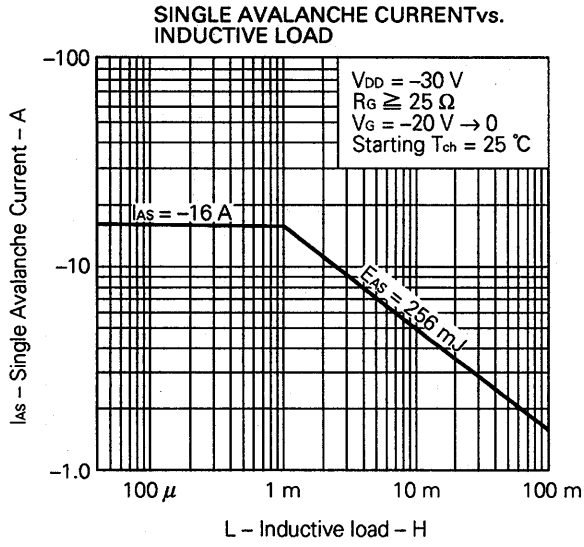
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE







Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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